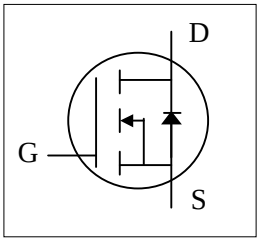
AP60T10GS/P-HF

Halogen-Free Product

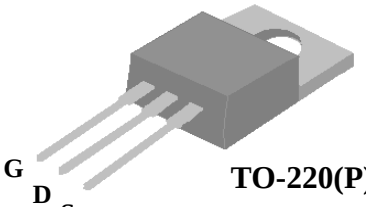
Advanced Power Electronics Corp.

N-CHANNEL ENHANCEMENT MODE POWER MOSFET

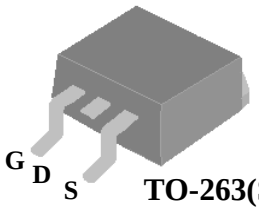
- **Simple Drive Requirement**
- **Lower On-resistance**
- **Fast Switching Characteristic**
- **RoHS Compliant & Halogen-Free**



BV_{DSS}	100V
$R_{DS(ON)}$	18mΩ
I_D	67A



TO-220(P)



TO-263(S)

Description

AP60T10 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.
The TO-263 package is widely preferred for all commercial-industrial surface mount applications using infrared reflow technique and suited for high current application due to the low connection resistance. The through-hole version (AP60T10GP) are available for low-profile applications.

Absolute Maximum Ratings@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D@T_C=25℃	Drain Current, V_{GS} @ 10V	67	A
I_D@T_C=100℃	Drain Current, V_{GS} @ 10V	42	A
I_{DM}	Pulsed Drain Current[1]	250	A
P_D@T_C=25℃	Total Power Dissipation	167	W
E_{AS}	Single Pulse Avalanche Energy[3]	288	mJ
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	0.75	℃/W
Rthj-a	Maximum Thermal Resistance, Junction-ambient (PCB mount)[4]	40	℃/W
Rthj-a	Maixmum Thermal Resistance, Junction-ambient	62	℃/W

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250uA	100	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance[2]	V_{GS}=10V, I_D=28A	-	-	18	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250uA	2	-	5	V
g_{fs}	Forward Transconductance	V_{DS}=25V, I_D=28A	-	45	-	S
I_{DSS}	Drain-Source Leakage Current	V_{DS}=80V, V_{GS}=0V	-	-	25	uA
I_{GSS}	Gate-Source Leakage	V_{GS}= ±20V, V_{DS}=0V	-	-	±100	nA
Q_g	Total Gate Charge	I_D=28A	-	55	90	nC
Q_{gs}	Gate-Source Charge	V_{DS}=80V	-	15	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	V_{GS}=10V	-	24	-	nC
$t_{d(on)}$	Turn-on Delay Time	V_{DS}=50V	-	16	-	ns
t_r	Rise Time	I_D=28A	-	68	-	ns
$t_{d(off)}$	Turn-off Delay Time	R_G=2.5Ω,V_{GS}=10V	-	29	-	ns
t_f	Fall Time	R_D=1.8Ω	-	42	-	ns
C_{iss}	Input Capacitance	V_{GS}=0V	-	2800	4500	pF
C_{oss}	Output Capacitance	V_{DS}=25V	-	400	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	155	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage[2]	I_S=28A, V_{GS}=0V	-	-	1.3	V
t_{rr}	Reverse Recovery Time	I_S=28A, V_{GS}=0V	-	80	-	ns
Q_{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	270	-	nC

Notes:

1.Pulse width limited by Max. junction temperature.

2.Pulse test

3.Starting T_j=25°C , V_{DD}=50V , L=1mH , R_G=25Ω , I_{AS}=24A.

4.Surface mounted on 1 in^2 copper pad of FR4 board

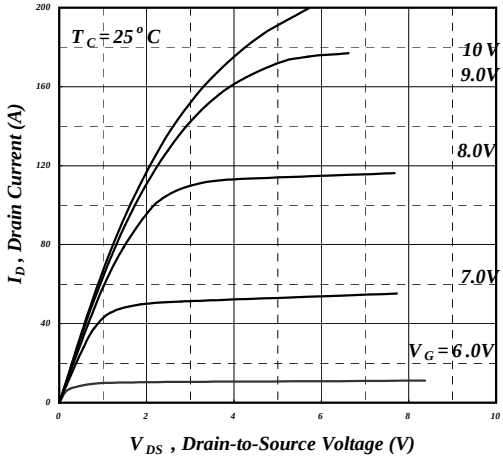


Fig 1. Typical Output Characteristics

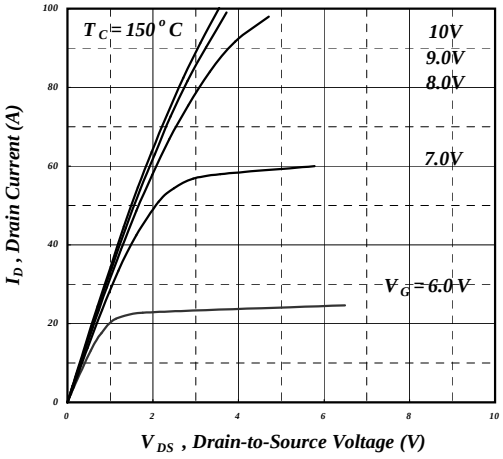


Fig 2. Typical Output Characteristics

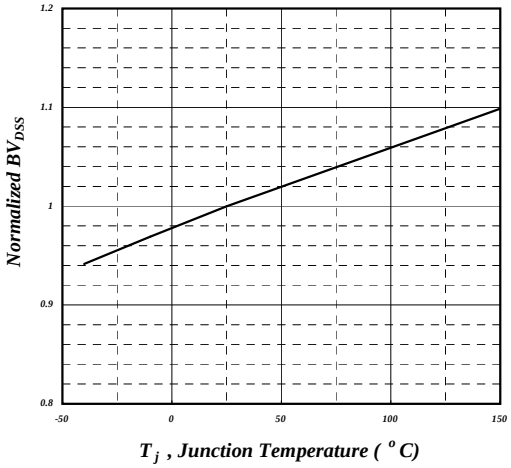


Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

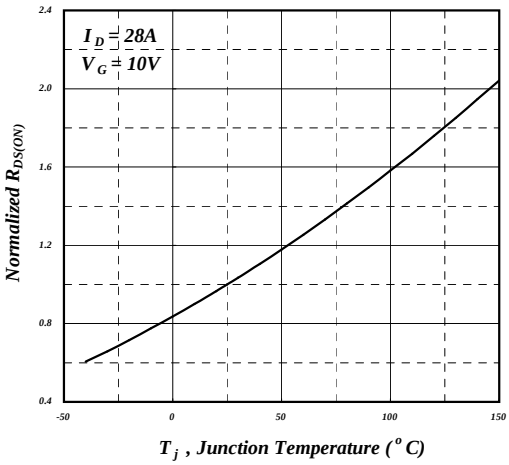


Fig 4. Normalized On-Resistance v.s. Junction Temperature

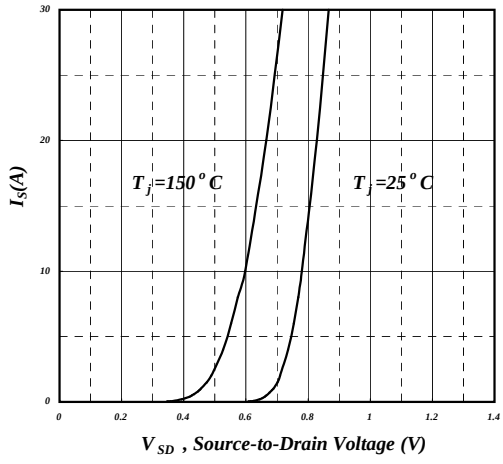


Fig 5. Forward Characteristic of Reverse Diode

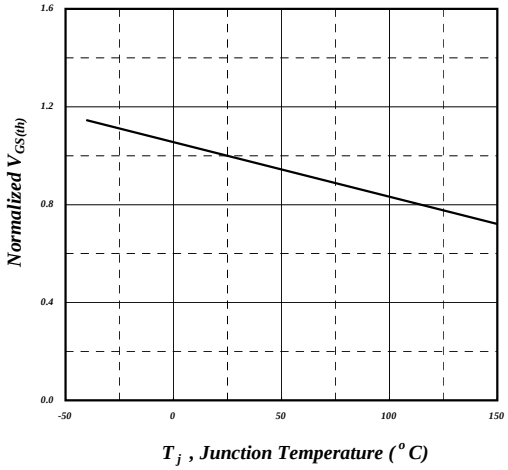


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

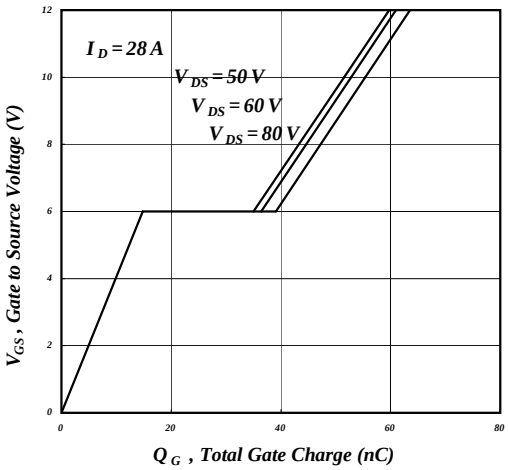


Fig 7. Gate Charge Characteristics

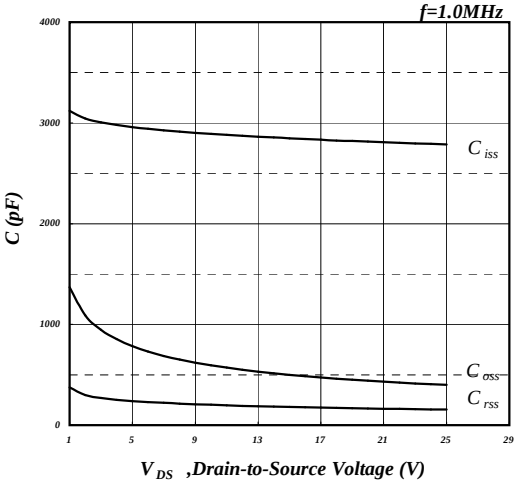


Fig 8. Typical Capacitance Characteristics

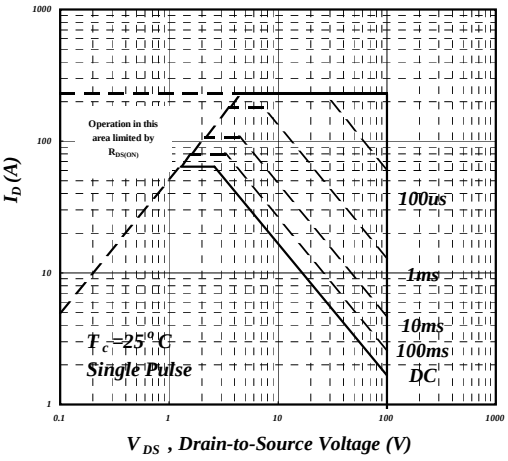


Fig 9. Maximum Safe Operating Area

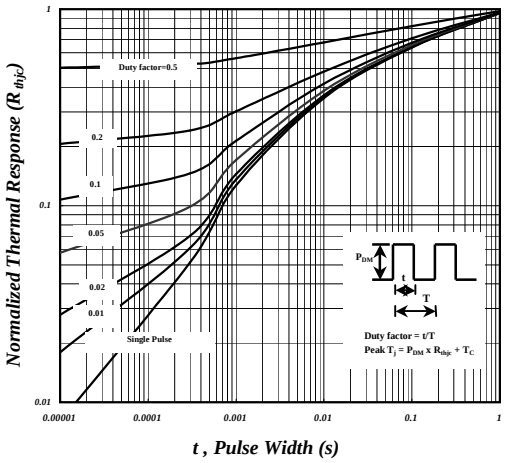


Fig 10. Effective Transient Thermal Impedance

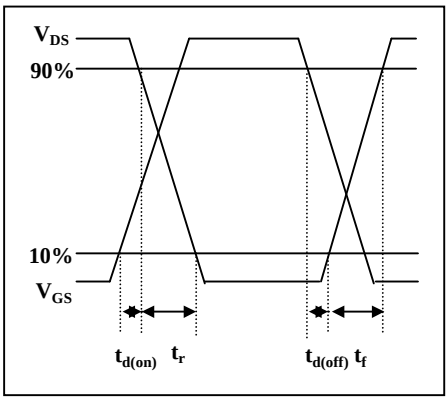


Fig 11. Switching Time Waveform

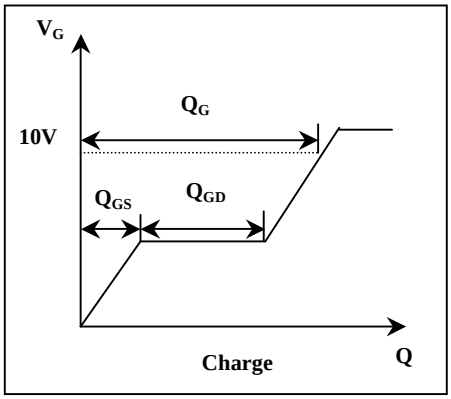
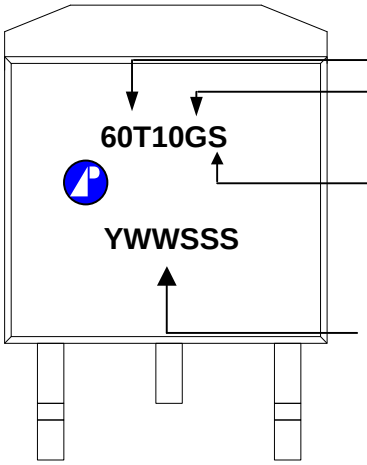


Fig 12. Gate Charge Waveform

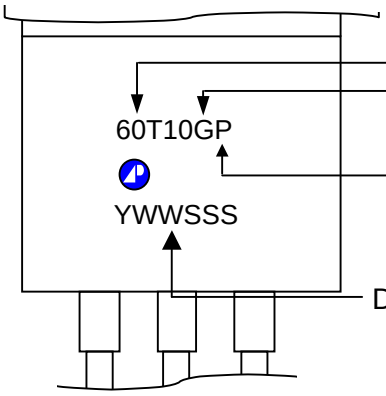
MARKING INFORMATION

TO-263



Part Number
meet Rohs requirement
for low voltage MOSFET only
Package Code
Date Code (YWWSSS)
Y：Last Digit Of The Year
WW：Week
SSS：Sequence

TO-220



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